

JNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.

10/622,346

Confirmation No. 4811

First Inventor

Sirinorakul

Filing Date

07/19/2003

Tech. Center/

2811

Examiner

Douglas W. Owens

Art Unit

Title:

Semiconductor Package Including Leadframe Roughened Using

Chemical Etchant To Prevent Separation Between Leadframe

And Molding Compound

Docket No.:

NSE006 US

Customer No.:

34036

Santa Clara, California December 2, 2005

MAIL STOP AMENDMENT COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to Office Action dated August 3, 2005, please amend the aboveidentified application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Amendments to the Drawings begin on page 7 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 8 of this paper.

An **Appendix** including amended drawing figures is attached following page 8 of this paper.